To: I. B. Patel

Fax 703 746-3448 Total of 4 pages

From: Gregory Bruns

Ph.: 952 926-0862

Fax: 952 925-5020

INFORMAL AMENDMENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Minneapolis, Minnesota April 21, 2003

Applicant:

Spielberger, et al.

Group:

2827

Serial No.:

09/998,348

Examiner:

Patel

Filed:

November 30, 2001

Atty. Docket No.:

H0002128-US

For:

BALL GRID ARRAY PACKAGE

AMENDMENT

Honorable Commissioner for Patents Box Non-Fee Amendment Washington, D.C. 20231

Dear Sir or Madam:

Responsive to the Official Communication having a mailing date of December 18, 2002, please amend the above application as follows relative to the amendment filed on March 18, 2003:

Amendments to the Claims

Claim 1 (currently amended). A ball grid array mounted circuit comprising:

a flexible stress relief substrate having a top surface and a bottom surface; spaced conductive vias extending between the top surface and said bottom surface;

- 1 -